

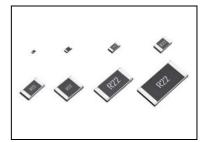
Low ohmic thick film chip resistors

MCR series - low ohmic -

Datasheet

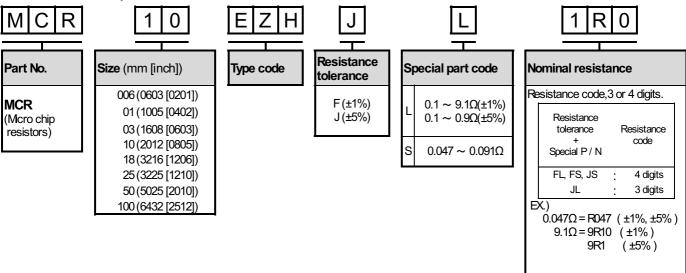
Features

- 1) Very-low ohmic resistance from $47m\Omega$ is in linear by thick-film resistive element.
- 2) ROHM resistors have obtained ISO9001 / ISO / TS16949 certification.



	Si	ze		Packaging		Automotive
Part No.	(mm)	(inch)	Type code	specifications	Quantity / Reel	grade available
MCR006	0603	0201	YLP	Paper tape(2mmpitch)	15,000	Yes
MCR01	1005	0402	MZP	Paper tape(2mmpitch)	10,000	Yes
MCR03	1608	0603	EZP	Paper tape(4mmpitch)	5,000	Yes
MCR10	2012	0805	EZH	Paper tape(4mmpitch)	5,000	Yes
MCR18	3216	1206	EZH	Paper tape(4mmpitch)	5,000	Yes
MCR25	3225	1210	JZH	Embossed tape(4mm pitch)	4,000	Yes
MCR50	5025	2010	JZH	Embossed tape(4mm pitch)	4,000	Yes
MCR100	6432	2512	JZH	Embossed tape(4mm pitch)	4,000	Yes

● Part number description

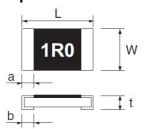


Products list

Part No.	Type code	Rated power (70°C) (W)	Limiting element voltage (V)	Temperature coefficient (ppm / °C)	Resistance tolerance (%)	Resistand	· ·	Operating temperature range (°C)
MCR006	YLP	0.05	0.67	+600/-200	F(±1%)	1.0≦R≦9.1	(E24 series)	-55 ~ +125
MCR01	MZP	0.063	0.76	±400	F(±1%)	1.0≦R≦9.1	(E24 series)	-55 ~ +155
MCR03	EZP	0.1	0.95	±400	F(±1%)	1.0≦R≦9.1	(E24 series)	-55 ~ +155
MCR10	EZH	0.25	1.51	500±300 400±200 ±250 500±300 400±200 ±250	J(±5%) J(±5%) J(±5%) F(±1%) F(±1%) F(±1%)	0.047≦R≦0.091 0.1≦R≦0.13 0.15≦R≦0.91 0.047≦R≦0.091 0.1≦R≦0.13 0.15≦R≦9.1	(E24 series) (E24 series) (E24 series) (E24 series) (E24 series) (E24 series)	-55 ~ +155
MCR18	EZH	0.25	1.51	500±300 400±200 ±250 500±300 400±200 ±250	J(±5%) J(±5%) J(±5%) F(±1%) F(±1%) F(±1%)	0.047≦R≤0.091 0.1≦R≤0.13 0.15≦R≤0.91 0.047≦R≤0.091 0.1≦R≤0.13 0.15≦R≤9.1	(E24 series) (E24 series) (E24 series) (E24 series) (E24 series) (E24 series)	55 ~ +155
MCR25	JZH	0.5	2.13	300±300 ±200 300±300 ±200	J(±5%) J(±5%) F(±1%) F(±1%)	0.047≦R≦0.091 0.1≦R≦0.91 0.047≦R≦0.091 0.1≦R≦9.1	(E24 series) (E24 series) (E24 series) (E24 series)	-55 ~ +155
MCR50	JZH	0.5	2.13	500±300 400±200 ±250 500±300 400±200 ±250	J(±5%) J(±5%) J(±5%) F(±1%) F(±1%) F(±1%)	0.047≦R≦0.091 0.1≦R≦0.13 0.15≦R≦0.91 0.047≦R≦0.091 0.1≦R≦0.13 0.15≦R≦9.1	(E24 series) (E24 series) (E24 series) (E24 series) (E24 series) (E24 series)	-55 ~ +155
MCR100	JZH	1	3.01	500±300 400±200 ±250 500±300 400±200 ±250	J(±5%) J(±5%) J(±5%) F(±1%) F(±1%) F(±1%)	0.047≦R≤0.091 0.1≤R≤0.13 0.15≦R≤0.91 0.047≦R≤0.091 0.1≤R≤0.13 0.15≤R≤9.1	(E24 series) (E24 series) (E24 series) (E24 series) (E24 series) (E24 series)	-55 ~ +125

^{*} Design and specifications are subject to change without notice. Carefully check the specification sheet supplied with the product before using or ordering it.

● Chip resistor dimensions and markings



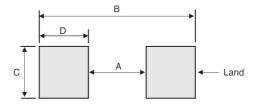
<Marking method>

There are three or four digits used for the calculation number according to IEC code and "R"is used for the decimal point.

(Unit:mm)

								(Oriicititi)	
Part No.	Type code	(mm)	(inch)	L	W	t	а	b	Marking existence
MCR006	YLP	0603	0201	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05	No
MCR01	MZP	1005	0402	1.00 ±0.05	0.50 ±0.05	0.35±0.05	0.20±0.10	0.25 ^{+0.05} _{-0.10}	No
MCR03	EZP	1608	0603	1.60 ±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20	3digits
MCR10	EZH	2012	0805	2.0±0.10	1.25±0.10	0.55±0.10	0.4±0.20	0.4±0.20	Yes
MCR18	EZH	3216	1206	3.20±0.15	1.60 ±0.15	0.55±0.10	0.50±0.25	0.50±0.25	Yes
MCR25	JZH	3225	1210	3.20±0.15	2.50 ±0.15	0.55±0.10	0.50±0.25	0.50±0.25	Yes
MCR50	JZH	5025	2010	5.00±0.15	2.50 ±0.15	0.55±0.15	0.60±0.25	0.60±0.25	Yes
MCR100	JZH	6432	2512	6.30±0.15	3.20±0.15	0.55±0.15	0.60±0.25	0.60±0.25	Yes

●Land pattern example



(Unit:mm)

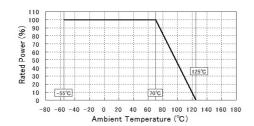
					(Grittini)
Dimensions Part No.	Type code	Α	В	С	D
MCR006	YLP	0.3	0.84	0.3	0.27
MCR01	MZP	0.5	1.3	0.5	0.4
MCR03	EZP	1.0	2.0	0.8	0.5
MCR10	EZH	1.2	2.6	1.15	0.7
MCR18	EZH	2.2	4.0	1.5	0.9
MCR25	JZH	2.2	4.0	2.3	0.9
MCR50	JZH	3.8	6.0	2.3	1.1
MCR100	JZH	5.1	8.1	3.0	1.5

MCR series - low ohmic - Datasheet

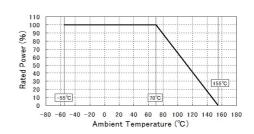
Derating curve

When the ambient temperature exceeds 70°C, power dissipation must be adjusted according to the derating curves below.

■MCR 006 / 100



■MCR 01 / 03 / 10 / 18 / 25 / 50



Characteristics

Test items	Guaranteed value	Test conditions	
Resistance	See "Products list"	20°C	
Variation of resistance with temperature	See "Products list"	Measurement: +25/-55, +25/+125°C	
Overload	±(2.0%+0.005Ω)	Rated voltage(current)×2.5, 2s Maximum overload voltage	
Anew uniform coating of minimum of 95% of the surface being immersed and no soldering damage.		Rosin-ethanol solution25% (Wweight) Soldering condition: 245±5°C Duration of immersion: 2.0±0.5s	
Resistance to $\pm (1.0\% + 0.005\Omega)$ Soldering heat No remarkable abnormality on the appearance.		Soldering condition: 260±5°C Duration of immersion: 10±1s	
Rapid change of temperature	±(1.0%+0.005Ω)	Test temp: -55°c ~+125°c 100cycle(MCR006) -55°c ~+125°c 5cycle(MCR01/03/10/18/25/50/100)	
Damp heat, steady state	±(3.0%+0.005Ω)	40 °C, 93%(Relative humidity) Test time: 1,000h~1,048h	
Endurance at 70°C	±(3.0%+0.005Ω)	Rated voltage(current),70°C±3°C 1.5h:ON-0.5h:OFF Test time: 1,000h~1,048h	
Endurance	±(3.0%+0.005Ω)	125°C(MCR006/100) 155°C(MCR01/03/10/18/25/50) Test time: 1,000h~1,048h	
Resistance to solvent	\pm (1.0% + 0.005Ω)% MCR006only \pm (0.5% + 0.005Ω)	23±5°C, Immersion cleaning, 5±0.5min, Solvent: 2-propanol	
Bend strength of the end face plating	Without mechanical damage such as breaks.	-	

Compliance Standard(s): IEC60115-8

JISC 5201-8

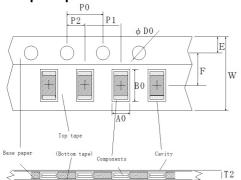
MCR006	MCR01	MCR03	MCR10	MCR18	MCR25	MCR50	MCR100
1.34V	1.52V	1.90V	3.02V	3.02V	4.26kV	4.26kV	6.02V

(Unit:mm)

3.5^{+0.15}_{-0.05}

●Tape dimensions

■Paper tape



Part No.	Type code	W	F	Е	A0	В0
MCR006	YLP	8.0±0.2	3.5±0.05	1.75±0.1	0.38±0.03	0.68±0.03
MCR01	MZP	8.0±0.3	3.5±0.05	1.75±0.1	0.7±0.1	1.2±0.1
MCR03	EΖP	8.0±0.3	3.5±0.05	1.75±0.1	1.1±0.1	1.9±0.1
MCR10	EΖΗ	8.0±0.3	3.5±0.05	1.75±0.1	1.65 ^{+0.2} -0.1	2.4 ^{+0.2} -0.1

1.75±0.1

1.95^{+0.1}_{-0.05}

 3.5 ± 0.05

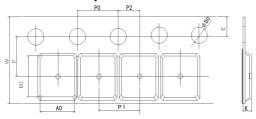
 8.0 ± 0.3

MCR18

EZH

Part No.	Type code	DO	P0	P1	P2	T2
MCR006	YLP	Ф1.5 ^{+0.1}	4.0±0.1	2.0±0.05	2.0±0.05	MAX 0.50
MCR01	MZP	Ф1.5 ^{+0.1}	4.0±0.1	2.0±0.05	2.0±0.05	MAX1.1
MCR03	EZP	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MCR10	EΖH	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MCR18	EZH	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

■ Embossed tape

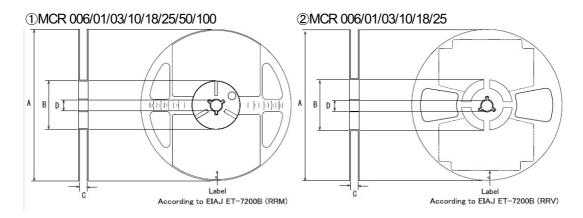


(Unit:mm)

Part No.	Type code	W	F	Е	A0	ВО
MCR25	JZH	8.0±0.3	3.5±0.05	1.75±0.1	3.0±0.1	3.5±0.1
MCR50	JZH	12.0±0.3	5.5±0.05	1.75±0.1	3.4±0.2	5.6±0.2
MCR100	JZH	12.0±0.3	5.5±0.05	1.75±0.1	3.5±0.2	6.7±0.2

Part No.	Type code	D0	P0	PI	P2	T2
MCR25	JZH	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MCR50	JZH	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1
MCR100	JZH	Ф1.5 ^{+0.1}	4.0±0.1	4.0±0.1	2.0±0.05	MAX1.1

Reel dimensions



-		=			(Unit:mm)
Part No.	Type code	Α	В	С	D
MCR006	YLP				
MCR01	MZP				
MCR03	EZP			9 ^{+1.0}	
MCR10	EZH	Ф180 0	Ф60 ^{+1.0}	90	Ф13±0.2
MCR18	EZH	^{Ψ100} -1.5	0		Ψ13±0.2
MCR25	JZH				
MCR50	JZH			13,+1.0	
MCR100	JZH			130	

Notice

Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

Ť	JÁPAN	USA	EU	CHINA
	CLASSⅢ	CLASSIII	CLASS II b	СГУССШ
	CLASSIV	CLASSIII	CLASSIII	CLASSII

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data.
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Notice-PAA-E Rev.003

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- 2. All information contained in this docume nt is current as of the issuing date and subj ect to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this doc ument is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

Rev.001



MCR100JZHFL - Web Page

Distribution Inventory

Part Number	MCR100JZHFL
Package	
Unit Quantity	4000
Minimum Package Quantity	4000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Thick Film Resistors category:

Click to view products by ROHM manufacturer:

Other Similar products are found below:

MCR03EZPFX3162 MCR004YZPJ332 201007J022KT4E 201007F1653T4E 201007F6652T4E 0603WAF137KT5E RTT204702FTE

RTT203000FTE RTT2056R0FTE CR2010F470KE04Z RTT018451FTH RTT021802DTH 0402WGF510LTCE 0201WMJ0200TEE

TR0603B26K7P0550Z 0201WMF5102TEE 1210W2J047KT5E YLR12-2-4F-W HOT(0.25x1.3)-3.2-0R-I HOT(0.4x1.5)-5.2-0R-I

HoT(0.45x1.5)-8.2-0R-I 0201WMF1103TEE 0201WMF7152TEE 1210W2J0124T5E 201007J010LT4E 201007J0360T4E 201007J0430T4E

0805W8F931KT5E 1206W4F5231T5E 1210W2J0620T5E 201007J0822T4E 0201WMF1005TCE 0201WMF1212TCE 0201WMF1373TCE

0201WMF1400TCE 0201WMF2000TEE 0201WMF2001TCE 0201WMF226JTCE 0201WMF2672TCE 0201WMF2803TCE

0201WMF357JTCE 0201WMF3743TCE 0201WMF430JTCE 0201WMF4990TCE 0201WMF5104TCE 0201WMF510JTEE